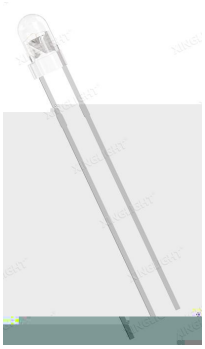
XL-304UWC F3

特点（ ）：



* : F3/3.8*3.0*5.2*28mm

Appearance dimension: F3/3.8*3.0*5.2*28mm

* : /

Luminous color and colloid: white brightness White /water colloid

* ROHS

Environmental protection products meet ROHS requirements

* MSL :2

Moisture sensitivity level MSL : 2 levels

* EIA

EIA standard packaging

*

Long operating life

*

High energy efficiency, fast startup

*

Low voltage DC drive

应用领域（ ）：

* ;

Home appliances, digital, communication

*

Automotive Electronics

*

Lighting decoration

*

electronic toy

*

electronic clock

*

Traffic instructions

*

Medical beauty instruments

*

Electronic teaching equipment

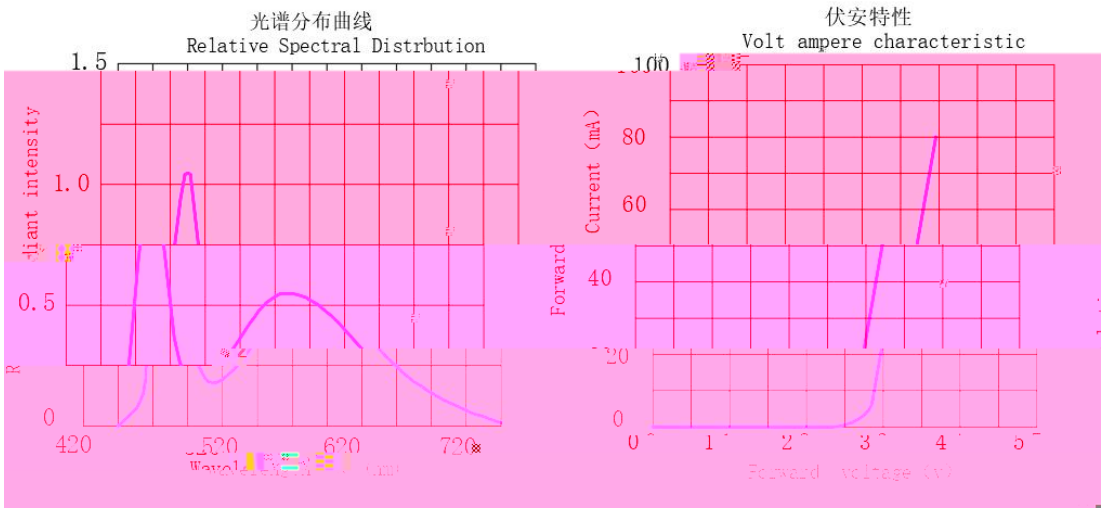
*

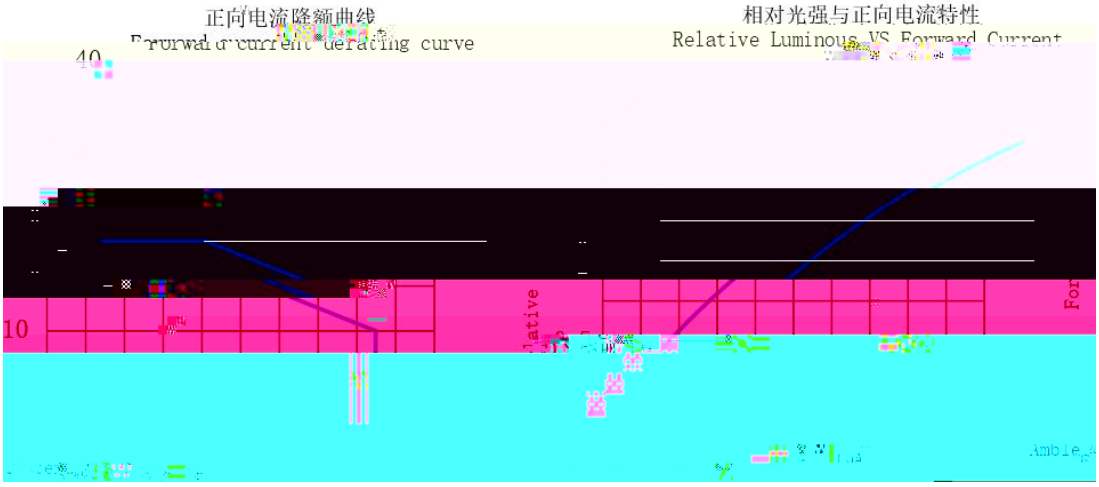
Urban lighting

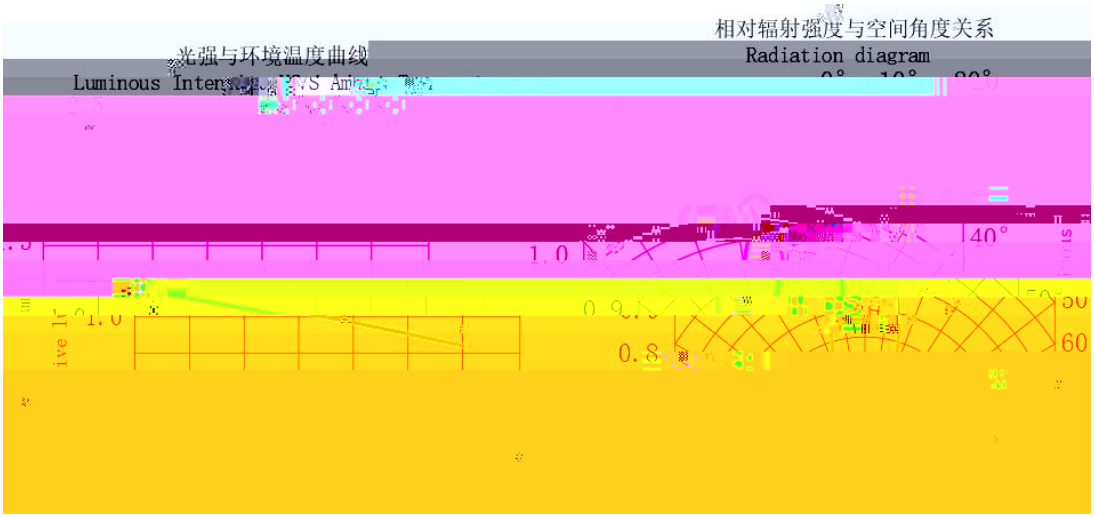
电性参数

Parameter	Symbol	Rating	Unit
Consumed power	Pd	70	mW
Max Continuous Forward Current	IF	20	mA
Peak Forward Current	IFp	80	mA
Operating ambient temperature	Topr	-20 C ~ +85 C	
Storage ambient temperature	Tstg	-40 C ~ +85 C	
Welding conditions	Tsol	reflow sr	

典型特性曲线







25±5 /Note If not otherwise indicated the test environment temp erature is 25±5

可靠性试验

Rehabinty Test Items And Conditions

Class	Test item	Testing environment	Testing time	Qty	Failqty
Endurance test	Working life	Ta=25 ±5 ,IF=20mA	1000hrs	22 PCS	0/1
	High temperature and high humidity experiment	Ta= 85±5 , RH= 85 90%	1000hrs	22 PCS	0/1
	High-temperature storage	Ta= 85±5	1000hrs	22 PCS	0/1
	Low temperature storage	Ta= -40±5	1000hrs	22 PCS	0/1
Environmental testing	Cold and hot cycle	100 ±5 30mins 5mins -40 ±5 30mins	100 Circles	22 PCS	0/1
	Hot and cold impact	105 ±5 5mins -45 ±5 5mins	100 Circles	22 PCS	0/1
Mechanical Test	Resistance to Soldering Heat	T.sol= 250 ± 5	2times	22 PCS	0/1
	Lead Integrity	Load 2.5N(0.25kgf) 0°~ 90° ~0°	3times	22 PCS	0/1

XINGLIGHT®

使用注意事项（ ）

1.
LED

This LED can be used in some ordinary electronic equip
house decoration, if LED is used in some high reliability
medical liao equipment, must refer to the information pr

使用注意事项（ ）

使用注意事项（ ）

8、其他事项：

*

*When handling the product, touching the encapsulant with bare hands will not only contaminate its surface, but also affect on its optical characteristics. Excessive force to the encapsulant might result in catastrophic failure of the LEDs due to die breakage or wire deformation. For this reason, please do not put excessive stress on LEDs, especially when the LEDs are heated such as during Reflow Soldering.